

# <IGBT Modules>

# CM600DX-24T1/CM600DXP-24T1

**HIGH POWER SWITCHING USE INSULATED TYPE** 

		Collector current I <sub>c</sub> 6 0 0 A
		Collector-emitter voltage V_{CES} 1 2 0 0 V
		Maximum junction temperature T <sub>vjmax</sub> <b>1 7 5</b> °C
DX		●Flat base type
	Con II Ant	<ul> <li>Copper base plate (Nickel-plating)</li> </ul>
		<ul> <li>RoHS Directive compliant</li> </ul>
		<ul> <li>Tin-plating pin terminals</li> </ul>
	e e	Collector current Ic 600 A
	and the second s	Collector-emitter voltage V_{CES} 1 2 0 0 V
		Maximum junction temperature $T_{vjmax}$ <b>1 7 5</b> °C
DXP	P AND AND P	●Flat base type
		<ul> <li>Copper base plate (Nickel-plating)</li> </ul>
	and a set	RoHS Directive compliant
		<ul> <li>Tin-plating pressfit terminals</li> </ul>
	dual switch (half-bridge)	●UL Recognized under UL1557, File No. E323585

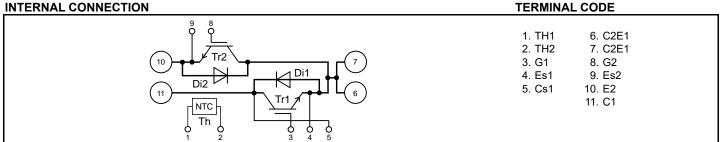
### APPLICATION

AC Motor Control, Motion/Servo Control, Power supply, etc.

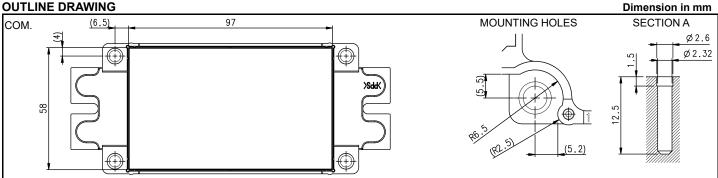
### **OPTION** (Below options are available.)

- •PC-TIM (Phase Change Thermal Interface Material) pre-apply
- •V<sub>CEsat</sub> selection for parallel connection

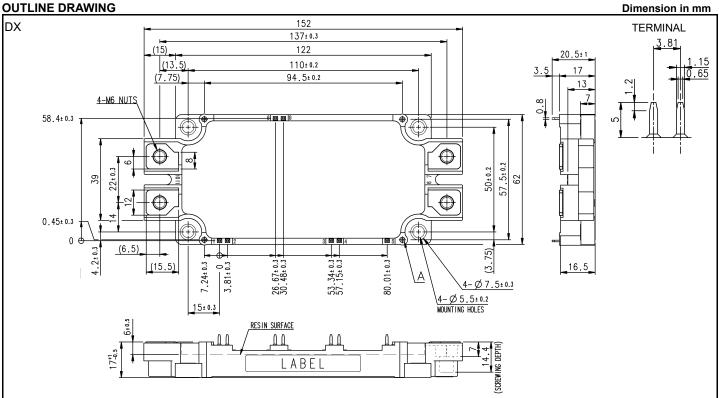
### INTERNAL CONNECTION



### **OUTLINE DRAWING**



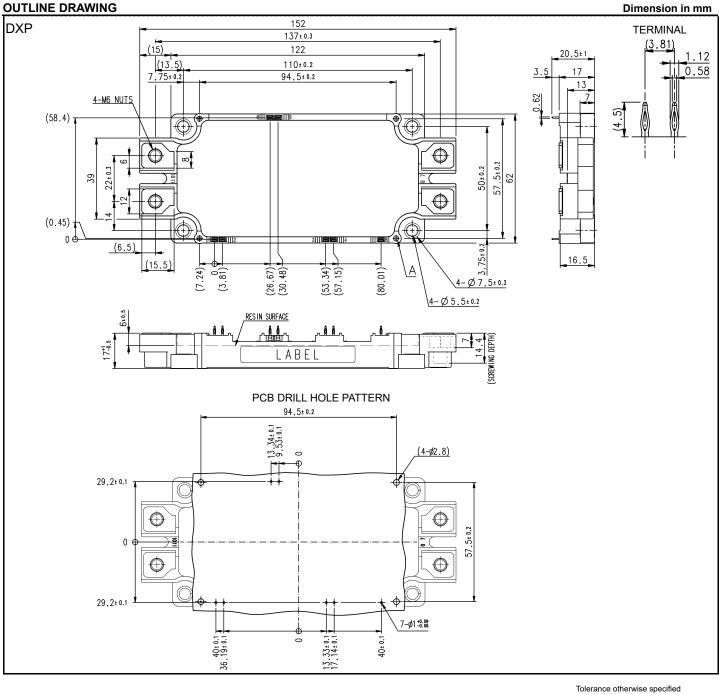




#### Tolerance otherwise specified

Division	Tolerance			
0.5		to	3	±0.2
over	3	to	6	±0.3
over	6	to	30	±0.5
over	30	to	120	±0.8
over 120		to 400		±1.2





Folerance	otherwise	specified

Division of	Tolerance		
0.5	to 3	±0.2	
over 3	to 6	±0.3	
over 6	to 30	±0.5	
over 30	to 120	±0.8	
over 120	to 400	±1.2	

# MAXIMUM RATINGS (Tvj=25 °C, unless otherwise specified) INVERTER PART IGBT/FWD

Symbol	Item	Conditions	Rating	Unit
V <sub>CES</sub>	Collector-emitter voltage	G-E short-circuited	1200	V
$V_{\text{GES}}$	Gate-emitter voltage	C-E short-circuited	± 20	V
lc	Collector current	DC, T <sub>C</sub> =86 °C (Note2, 4)	600	^
I <sub>CRM</sub>		Pulse, Repetitive (Note3)	1200	A
Ptot	Total power dissipation	Tc=25 °C (Note2, 4)	2500	W
IE (Note1)	Emitter eurrent	DC (Note2)	600	^
IERM (Note1)	Emitter current	Pulse, Repetitive (Note3)	1200	A

#### MODULE

Symbol	Item Conditions		Rating	Unit
Visol	Isolation voltage	on voltage Terminals to base plate, RMS, f=60 Hz, AC 1 min		V
T <sub>vjmax</sub>	Maximum junction temperature Instantaneous event (overload) <sup>(Note9)</sup>		175	°C
T <sub>Cmax</sub>	Maximum case temperature	(Note4, 9)	125	
Tvjop	Operating junction temperature	Continuous operation (under switching) (Note9)	-40 ~ +150	°C
Tstg	Storage temperature	-	-40 ~ +125	C

# ELECTRICAL CHARACTERISTICS ( $T_{vj}$ =25 °C, unless otherwise specified) INVERTER PART IGBT/FWD

Symbol	Item	Conditiona	Conditions		Limits			
Symbol		Conditions		Min.	Тур.	Max.	Unit	
I <sub>CES</sub>	Collector-emitter cut-off current	V <sub>CE</sub> =V <sub>CES</sub> , G-E short-circuited		-	-	1.0	mA	
IGES	Gate-emitter leakage current	V <sub>GE</sub> =V <sub>GES</sub> , C-E short-circuited		-	-	0.5	μA	
$V_{GE(th)}$	Gate-emitter threshold voltage	I <sub>C</sub> =60 mA, V <sub>CE</sub> =10 V		5.4	6.0	6.6	V	
		I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V,	T <sub>vj</sub> =25 °C	-	1.90	2.25		
V <sub>CEsat</sub>		Refer to the figure of test circuit	T <sub>vj</sub> =125 °C	-	2.15	-	V	
(Terminal)		(Note5)	T <sub>vj</sub> =150 °C	-	2.25	-		
	Collector-emitter saturation voltage	Ic=600 A,	T <sub>vi</sub> =25 °C	-	1.70	2.00		
V <sub>CEsat</sub> (Chip)		V <sub>GE</sub> =15 V,	T <sub>vi</sub> =125 °C	-	1.95	-	V	
		(Note5)	T <sub>vi</sub> =150 °C	-	2.05	-		
Cies	Input capacitance		,	-	-	109.1	1	
Coes	Output capacitance	V <sub>CE</sub> =10 V, G-E short-circuited		-	-	3.1	nF	
Cres	Reverse transfer capacitance			-	-	1.4		
Q <sub>G</sub>	Gate charge	V <sub>CC</sub> =600 V, I <sub>C</sub> =600 A, V <sub>GE</sub> =15 V		-	3.4	-	μC	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>cc</sub> =600 V, I <sub>c</sub> =600 A, V <sub>GE</sub> =±15 V,		-	-	600	- ns	
tr	Rise time			-	-	300		
t <sub>d(off)</sub>	Turn-off delay time			-	-	800		
t <sub>f</sub>	Fall time	- R <sub>G</sub> =1.0 Ω, Inductive load		-	-	400		
		I <sub>E</sub> =600 A, G-E short-circuited,	T <sub>vj</sub> =25 °C	-	1.90	2.35		
V <sub>EC</sub> (Note1)		Refer to the figure of test circuit	T <sub>vj</sub> =125 °C	-	1.95	-	V	
(Terminal)		(Note5)	T <sub>vj</sub> =150 °C	-	2.00	-		
()	Emitter-collector voltage	I <sub>E</sub> =600 A,	T <sub>vj</sub> =25 °C	-	1.75	2.10	1	
V <sub>EC</sub> (Note1)		G-E short-circuited,	T <sub>vj</sub> =125 °C	-	1.80	-	V	
(Chip)		(Note5)	T <sub>vj</sub> =150 °C	-	1.80	-		
t <sub>rr</sub> <sup>(Note1)</sup>	Reverse recovery time	V <sub>CC</sub> =600 V, I <sub>E</sub> =600 A, V <sub>GE</sub> =±15 V,		-	-	400	ns	
Q <sub>rr</sub> (Note1)	Reverse recovery charge	$R_G=1.0 \Omega$ , Inductive load		-	46.8	-	μC	
Eon	Turn-on switching energy per pulse	V <sub>cc</sub> =600 V, I <sub>c</sub> =I <sub>E</sub> =600 A,		-	53.0	-		
E <sub>off</sub>	Turn-off switching energy per pulse	V <sub>GE</sub> =±15 V, R <sub>G</sub> =1.0 Ω, T <sub>vi</sub> =150 °C,		-	56.0	-	m	
Err <sup>(Note1)</sup>	Reverse recovery energy per pulse	Inductive load		-	40.0	-	m	
R <sub>CC'+EE'</sub>	Internal lead resistance	Main terminals-chip, per switch, Tc=25	°C (Note4)	-	0.75	-	m۵	
r <sub>g</sub>	Internal gate resistance	Per switch		-	0.67	-	Ω	

# ELECTRICAL CHARACTERISTICS (cont.; $T_{vj}$ =25 °C, unless otherwise specified) NTC THERMISTOR PART

Symbol	Itom	Conditions		Unit		
	Item	Conditions	Min.	Тур.	Max.	Unit
R <sub>25</sub>	Zero-power resistance	Tc=25 °C (Note4)		5.00	5.15	kΩ
ΔR/R	Deviation of resistance	R <sub>100</sub> =493 Ω, T <sub>C</sub> =100 °C (Note4)	-7.3	-	+7.8	%
B <sub>(25/50)</sub>	B-constant	Approximate by equation (Note6)	-	3375	-	К
P <sub>25</sub>	Power dissipation	T <sub>C</sub> =25 °C (Note4)	-	-	10	mW

#### THERMAL RESISTANCE CHARACTERISTICS

Symbol	ltom	Conditions	Limits			Unit
	Item	Conditions	Min.	Тур.	Max.	Unit
$R_{th(j-c)Q}$	Thermal resistance	Junction to case, per Inverter IGBT (Note4)	-	-	60	K/kW
R <sub>th(j-c)D</sub>	Thermai resistance	Junction to case, per Inverter FWD (Note4)	-	-	87	r/kvv
$R_{th(c-s)}$	Contact thermal resistance	Case to heat sink, per 1 module, Thermal grease applied <sup>(Note4, 7, 9)</sup>	-	11.5	-	K/kW

### MECHANICAL CHARACTERISTICS

Sympol	Item	Conditions			Unit		
Symbol	item	Con	Conditions		Тур.	Max.	Unit
Mt	Mounting torque	Main terminals	M 6 screw	3.5	4.0	4.5	N∙m
Ms	Mounting torque	Mounting to heat sink	M 5 screw	2.5	3.0	3.5	N∙m
		Coldennin turne (DV)	Terminal to terminal	17	-	-	
	Creepage distance	Solder pin type (DX)	Terminal to base plate	16.4	-	-	mm
ds		Pressfit pin type (DXP)	Terminal to terminal	17	-	-	mm
			Terminal to base plate	16.8	-	-	
		Solder pin type (DX)	Terminal to terminal	10	-	-	mm
			Terminal to base plate	16.2	-	-	
da	Clearance	Dura of the instance (D)(D)	Terminal to terminal	10	-	-	
		Pressfit pin type (DXP) Terminal to base plate		16.2	-	-	mm
ec	Flatness of base plate	On the centerline X, Y (Note8)		±0	-	+200	μm
m	mass	-		-	300	-	g

\*. This product is compliant with the Restriction of the Use of Certain Hazardous Substances in Electrical and Electronic Equipment (RoHS) directive 2011/65/EU and (EU) 2015/863.

Note1. Represent ratings and characteristics of the anti-parallel, emitter-collector free-wheeling diode (FWD).

2. Junction temperature (T  $_{\nu j}$  ) should not increase beyond T  $_{\nu j\,m\,ax}$  rating.

3. Pulse width and repetition rate should be such that the device junction temperature  $(T_{vj})$  dose not exceed  $T_{vjmax}$  rating.

4. Case temperature (T<sub>C</sub>) and heat sink temperature (T<sub>S</sub>) are defined on the each surface (mounting side) of base plate and heat sink just under the chips. Refer to the figure of chip location.

5. Pulse width and repetition rate should be such as to cause negligible temperature rise. Refer to the figure of test circuit.

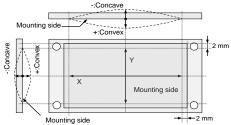
6. 
$$B_{(25/50)} = \ln(\frac{R_{25}}{R_{50}}) / (\frac{1}{T_{25}} - \frac{1}{T_{50}})$$

 $R_{25}\!\!:$  resistance at absolute temperature  $T_{25}$  [K];  $T_{25}\!=\!25$  [°C]+273.15=298.15 [K]

 $R_{50}$ : resistance at absolute temperature  $T_{50}$  [K];  $T_{50}\text{=}50$  [°C]+273.15=323.15 [K]

7. Reference value. Thermally conductive grease of thermal conductivity  $\lambda$ =0.9 W/(m·K) and thickness D<sub>(C-S)</sub>=50 µm.

8. The base plate (mounting side) flatness measurement points (X, Y) are shown in the following figure.



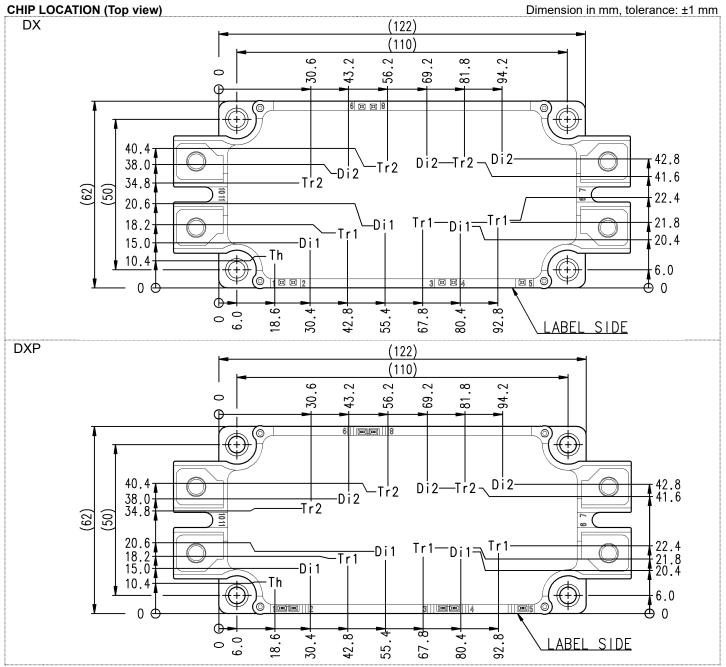
9. Long term performance related to thermal conductive grease (including but not limited to aspects such as the increase of thermal resistance due to pumping out, etc.) should be verified under user's specific application conditions. Each temperature condition (T<sub>vj max</sub>, T<sub>vj op</sub>, T<sub>C max</sub>) must be maintained below the maximum rated temperature throughout consideration of the temperature rise even for long term usage.

Note10. Use the following screws when mounting the printed circuit board (PCB) on the standoffs. PCB thickness : t1.6

	Туре	Manufacturer	Size	Tightening torque (N∙m)	Recommended tightening method
(1)	PT®	EJOT	K25×8	0.55 ± 0.055	
(2)	PT®		K25×10	0.75 ± 0.075 N∙m	by handwork (equivalent to 30 r/min
(3)	DELTA PT®		25×8	0.55 ± 0.055 N∙m	by mechanical screw driver)
(4)	DELTA PT®		25×10	0.75 ± 0.075 N∙m	~ 600 r/min (by mechanical screw driver)
(5)	B1	-	φ2.6×10	0.75 ± 0.075 N ⋅ m	
	tapping screw		φ2.6×12	0.75 ± 0.075 N•III	

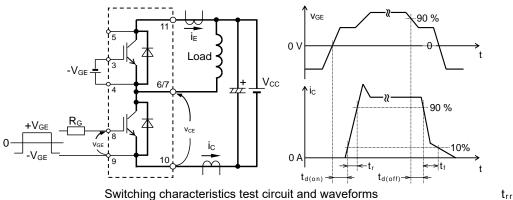
# **RECOMMENDED OPERATING CONDITIONS**

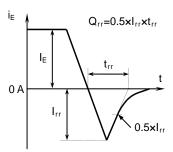
Svmbol	Item	Conditions	Limits			Unit
Symbol	item	Conditions	Min.	Тур.	Max.	Unit
V <sub>cc</sub>	(DC) Supply voltage	Applied across C1-E2 terminals	-	600	850	V
$V_{\text{GEon}}$	Gate (-emitter drive) voltage	Applied across G1-E1s/G2-E2s terminals	13.5	15.0	16.5	V
R <sub>G</sub>	External gate resistance	Per switch	1.0	-	6.8	Ω



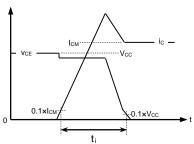
Tr1/Tr2: IGBT, Di1/Di2: FWD, Th: NTC thermistor

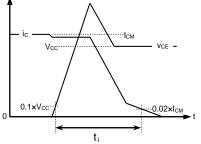






trr, Qrr characteristics test waveform

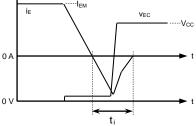




IGBT Turn-on switching energy

IGBT Turn-off switching energy

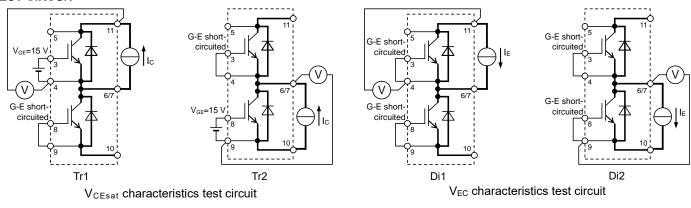
**↑** .



FWD Reverse recovery energy

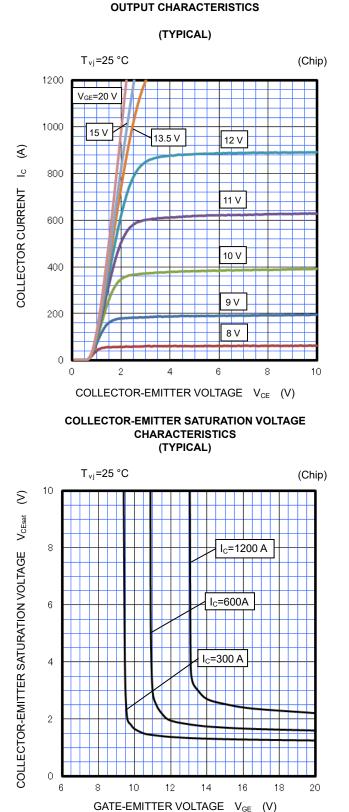
Switching energy and Reverse recovery energy test waveforms (Integral time instruction drawing)

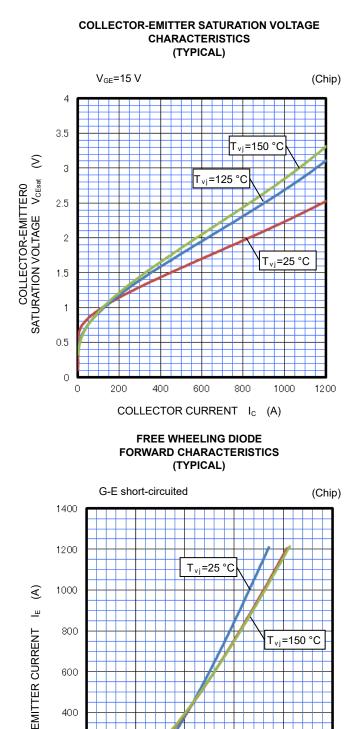
# **TEST CIRCUIT**



# PERFORMANCE CURVES

#### **INVERTER PART**





2

2.5

3

T<sub>vi</sub>=125 °C

EMITTER-COLLECTOR VOLTAGE V<sub>EC</sub> (V)

1.5

200

0

0.5

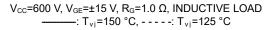
1

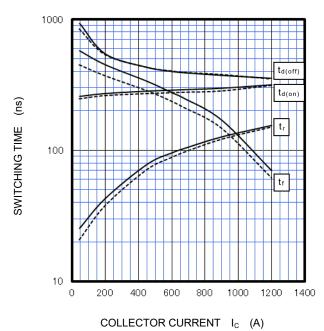
# PERFORMANCE CURVES

#### **INVERTER PART**

### HALF-BRIDGE SWITCHING CHARACTERISTICS

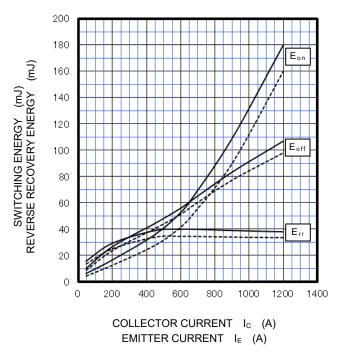
(TYPICAL)





HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)

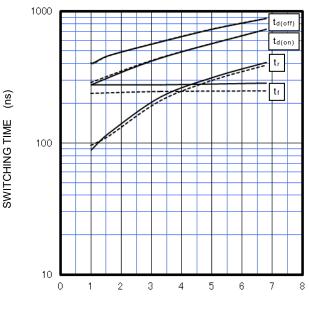
V<sub>CC</sub>=600 V, V<sub>GE</sub>=±15 V, R<sub>G</sub>=1.0 Ω, INDUCTIVE LOAD, PER PULSE ......: T<sub>vi</sub>=150 °C, ----: T<sub>vi</sub>=125 °C



#### HALF-BRIDGE SWITCHING CHARACTERISTICS

#### (TYPICAL)

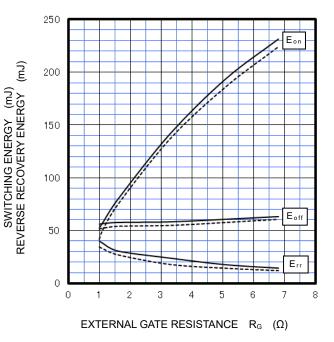
V<sub>CC</sub>=600 V, V<sub>GE</sub>=±15 V, I<sub>C</sub>=600 A, INDUCTIVE LOAD ------: T<sub>vi</sub>=125 °C



EXTERNAL GATE RESISTANCE  $R_G$  ( $\Omega$ )

# HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL)

V<sub>CC</sub>=600 V, V<sub>GE</sub>=±15 V, I<sub>C</sub>/I<sub>E</sub>=600 A, INDUCTIVE LOAD, PER PULSE ------: T<sub>vi</sub>=125 °C

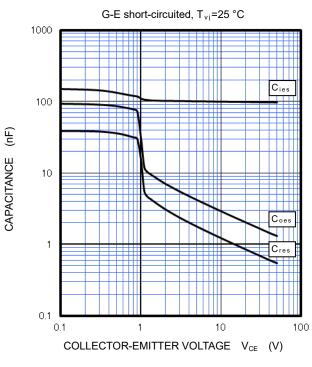


## PERFORMANCE CURVES

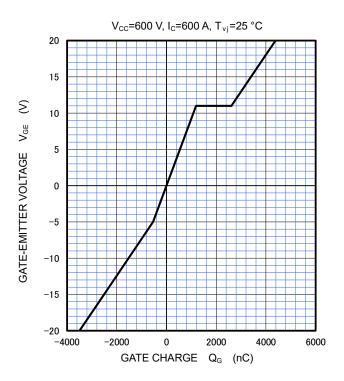
#### **INVERTER PART**

#### CAPACITANCE CHARACTERISTICS

#### (TYPICAL)

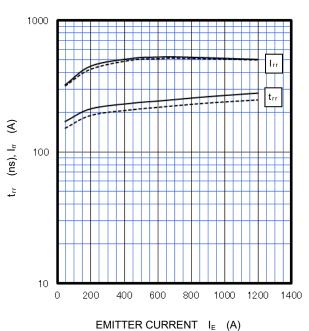


GATE CHARGE CHARACTERISTICS (TYPICAL)



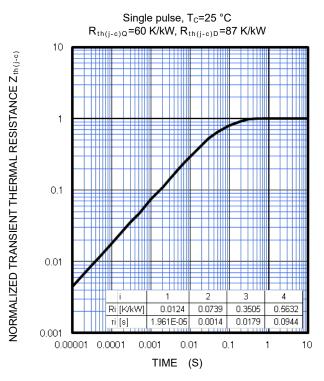
#### FREE WHEELING DIODE REVERSE RECOVERY CHARACTERISTICS (TYPICAL)

 $\begin{array}{c} V_{CC}{=}600 \ V, \ V_{GE}{=}{\pm}15 \ V, \ R_{G}{=}1.0 \ \Omega, \ \text{INDUCTIVE LOAD} \\ \hline \\ \hline \\ \hline \\ \hline \\ \end{array} \\ \begin{array}{c} T_{vi}{=}150 \ ^{\circ}\text{C}, \ -{---}{:} \ T_{vi}{=}125 \ ^{\circ}\text{C} \end{array}$ 



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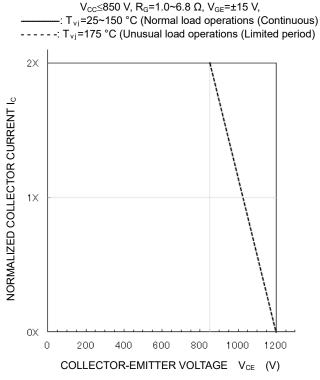
TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (MAXIMUM)



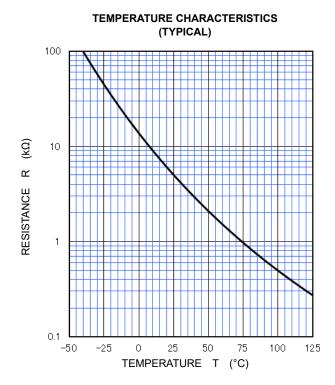
### PERFORMANCE CURVES

#### **INVERTER PART**

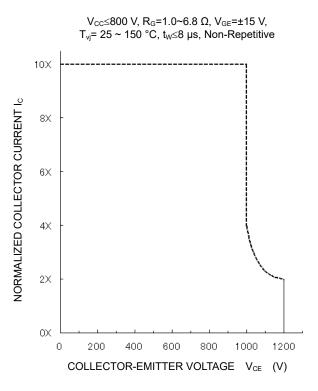
#### TURN-OFF SWITCHING SAFE OPERATING AREA (REVERSE BIAS SAFE OPERATING AREA) (MAXIMUM)



NTC thermistor part



SHORT-CIRCUIT SAFE OPERATING AREA (MAXIMUM)



Note: The characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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